

BIPOLAR ANALOG INTEGRATED CIRCUIT $\mu PC8215TU$

SIGE LOW NOISE AMPLIFIER FOR GPS/MOBILE COMMUNICATIONS

DATA SHEET

DESCRIPTION

The μ PC8215TU is a silicon germanium (SiGe) monolithic integrated circuit designed as low noise amplifier for GPS and mobile communications.

The package is 8-pin lead-less minimold suitable for surface mount.

This IC is manufactured using our 50 GHz fmax UHS2 (Ultra High Speed Process) SiGe bipolar process.

FEATURES

- Low noise
- : NF = 1.3 dB TYP. @ Vcc = 3.0 V
- High gain : $G_P = 27.0 \text{ dB TYP}$. @ Vcc = 3.0 V
- Low distortion : $OIP_3 = +12.5 \text{ dBm TYP}$. @ Vcc = 3.0 V
- High-density surface mounting : 8-pin lead-less minimold package (2.0 × 2.2 × 0.5 mm)
- High performance with minimum external components
- Output matched to 50 Ω

APPLICATION

• Low noise amplifier for GPS and mobile communications

ORDERING INFORMATION

Part Number	Order Number	Package	Marking	Supplying Form
μΡC8215TU-E2	μΡC8215TU-E2-A	8-pin lead-less minimold (Pb-Free) ^{№te}	8215	 8 mm wide embossed taping Pin 5, 6, 7, 8 indicates pull-out direction of tape Qty 5 kpcs/reel

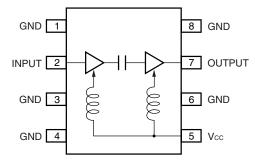
Note With regards to terminal solder (the solder contains lead) plated products (conventionally plated), contact your nearby sales office.

Remark To order evaluation samples, contact your nearby sales office. Part number for sample order: μ PC8215TU

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

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PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM



ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Test Conditions	Ratings	Unit
Supply Voltage	Vcc	TA = +25°C	4.0	V
Power Dissipation of Package	P₀	T _A = +85°C No	te 1.06	w
Operating Ambient Temperature	Ta		-40 to +85	°C
Storage Temperature	Tstg		-55 to +150	°C
Input Power	Pin		+10	dBm

Note Mounted on double-side copper-clad $50 \times 50 \times 1.6$ mm epoxy glass PWB

RECOMMENDED OPERATING RANGE

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Supply Voltage	Vcc	2.7	3.0	3.3	V
Operating Ambient Temperature	TA	-25	+25	+85	°C
Operating Frequency Range	fin	-	1 575	-	MHz

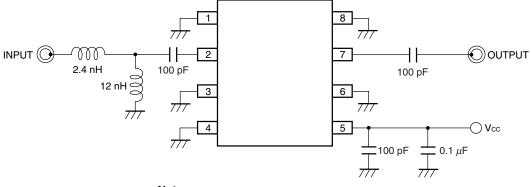
ELECTRICAL CHARACTERISTICS

(TA = +25°C, Vcc = 3.0 V, fin = 1 575 MHz, unless otherwise specified)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Circuit Current	lcc	No Signal	-	10.0	13.0	mA
Power Gain	G₽		24.0	27.0	30.0	dB
Noise Figure	NF		-	1.3	1.5	dB
Output 3rd Order Distortion Intercept Point	OIP ₃		-	+12.5	-	dBm
Input Return Loss	RLin		6.0	7.0	-	dB
Output Return Loss	RLout		10	14.0	-	dB
Isolation	ISL		30	40.0	-	dB
Gain 1 dB Compression Output Power	Po (1 dB)		-	+5.0	-	dBm

NEC

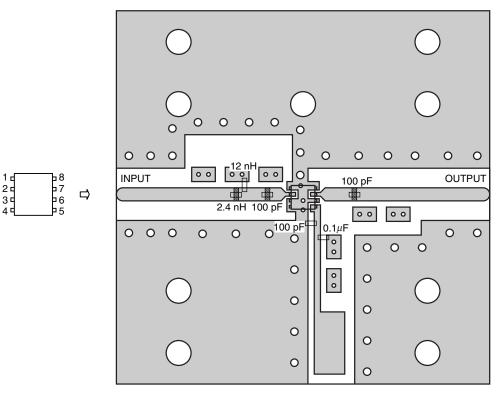
TEST CIRCUIT



Notes

- 1. High performance with minimum external components.
- 2. Output matched to 50 Ω .

ILLUSTRATION OF THE TEST CIRCUIT ASSEMBLED ON EVALUATION BOARD



Notes

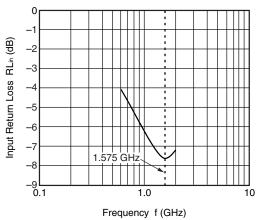
- 1. 30 \times 30 \times 0.51 mm double sided copper-clad hydrocarbon ceramic woven glass PWB (Rogers : R04003, $\varepsilon r = 3.38$).
- 2. Au plated on pattern
- 3. 12 nH/2.4 nH : Murata LQP15M
- 4. 100 pF/0.1 μF : Murata GRM15
- represents cutout 5.
- 6. oO: Through holes

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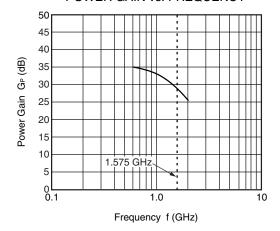
4

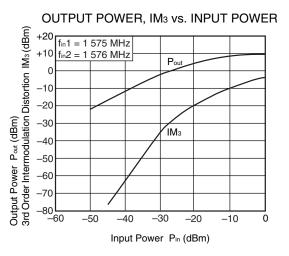
TYPICAL CHARACTERISTICS (TA = +25°C, Vcc = 3.0 V, unless otherwise specified)

INPUT RETURN LOSS vs. FREQUENCY

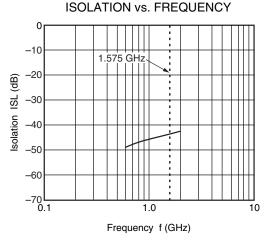


POWER GAIN vs. FREQUENCY

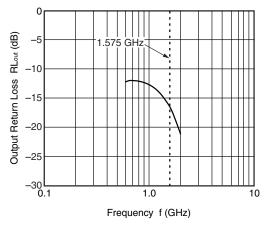




Remark The graphs indicate nominal characteristics.

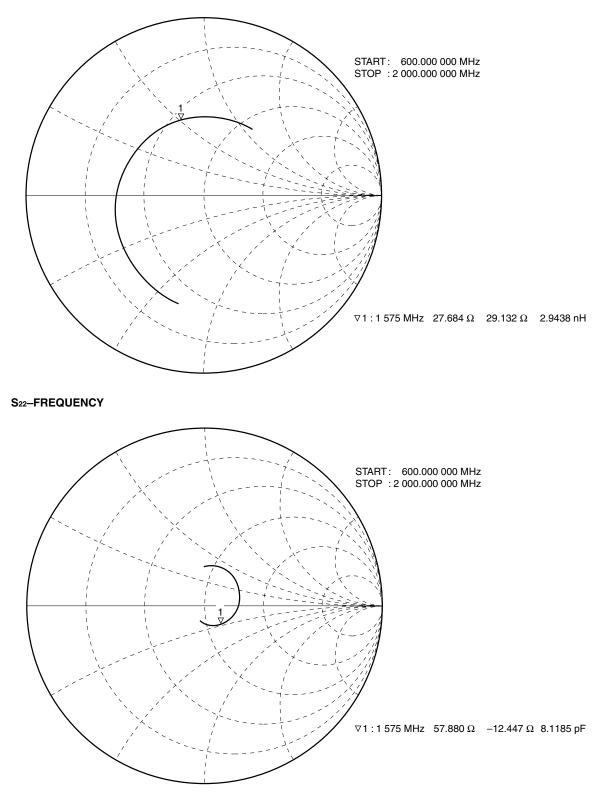


OUTPUT RETURN LOSS vs. FREQUENCY



S-PARAMETERS (T_A = +25°C, Vcc = 3.0 V, monitored at connector on board)

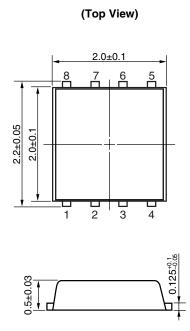


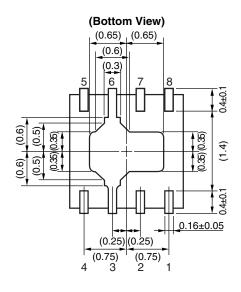


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PACKAGE DIMENSIONS

8-PIN LEAD-LESS MINIMOLD (UNIT: mm)





Remark (): Reference value

NOTES ON CORRECT USE

- (1) Observe precautions for handling because of electro-static sensitive devices.
- (2) Form a ground pattern as widely as possible to minimize ground impedance (to prevent undesired oscillation). All the ground terminals must be connected together with wide ground pattern to decrease impedance difference.
- (3) The bypass capacitor should be attached to Vcc line.

RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions		Condition Symbol
Infrared Reflow	Peak temperature (package surface temperature) Time at peak temperature Time at temperature of 220°C or higher Preheating time at 120 to 180°C Maximum number of reflow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 60 seconds or less : 120±30 seconds : 3 times : 0.2%(Wt.) or below	IR260
Wave Soldering	Peak temperature (molten solder temperature) Time at peak temperature Preheating temperature (package surface temperature) Maximum number of flow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 120°C or below : 1 time : 0.2%(Wt.) or below	WS260
Partial Heating	Peak temperature (terminal temperature) Soldering time (per side of device) Maximum chlorine content of rosin flux (% mass)	: 350°C or below : 3 seconds or less : 0.2%(Wt.) or below	HS350

Caution Do not use different soldering methods together (except for partial heating).

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► For further information, please contact

techinfo@ml.ncsd.necel.com (technical) Sales Division TEL: +81-44-435-1573 FAX: +81-44-435-1579

NEC Compound Semiconductor Devices Hong Kong Limited

E-mail: ncsd-hk@elhk.nec.com.hk (sales, technical and general)

_ · · · · · · · · · · · · · · · · · · ·					
Hong Kong Head Office	TEL: +852-3107-7303	FAX: +852-3107-7309			
Taipei Branch Office	TEL: +886-2-8712-0478	FAX: +886-2-2545-3859			
Korea Branch Office	TEL: +82-2-558-2120	FAX: +82-2-558-5209			

 NEC Electronics (Europe) GmbH
 http://www.ee.nec.de/

 TEL: +49-211-6503-0
 FAX: +49-211-6503-1327

California Eastern Laboratories, Inc. http://www.cel.com/ TEL: +1-408-988-3500 FAX: +1-408-988-0279